imall

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PHOTOCOUPLER PS9115

HIGH CMR, 10 Mbps TOTEM POLE OUTPUT TYPE 5-PIN SOP (SO-5) PHOTOCOUPLER -NEPOC Series-

DESCRIPTION

NEC

The PS9115 is an optically coupled high-speed, totem pole output isolator containing a GaAlAs LED on the input side and a photodiode and a signal processing circuit on the output side on one chip.

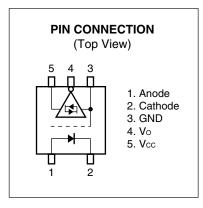
The PS9115 is specified high CMR, high CTR and pulse width distortion with operating temperature.

FEATURES

- High common mode transient immunity (CMH, CML = ±20 kV/μs TYP.)
- Small package (SO-5)
- Pulse width distortion ($|t_{PHL} t_{PLH}| = 7 \text{ ns TYP.}$)
- High-speed (10 Mbps)
- High isolation voltage (BV = 3 750 Vr.m.s.)
- Totem pole output
- Ordering number of taping product: PS9115-F3, F4: 2 500 pcs/reel
- Pb-Free product
- Safety standards
 - UL approved: File No. E72422
 - DIN EN60747-5-2 (VDE0884 Part2) approved No. 40008902 (Option)

APPLICATIONS

- Measurement equipment
- PDP
- Line Receiver for FA Network



TRUTH TABLE

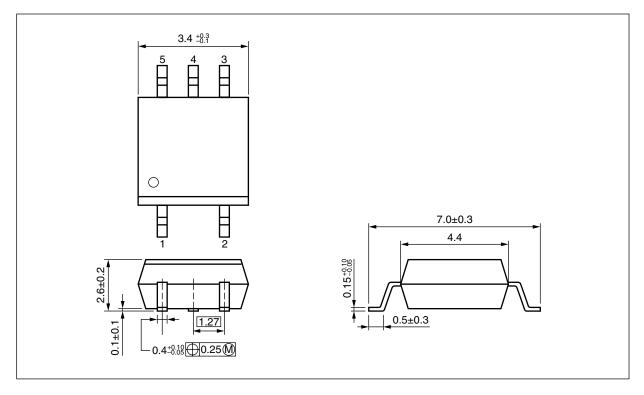
LED	Output
ON	L
OFF	н

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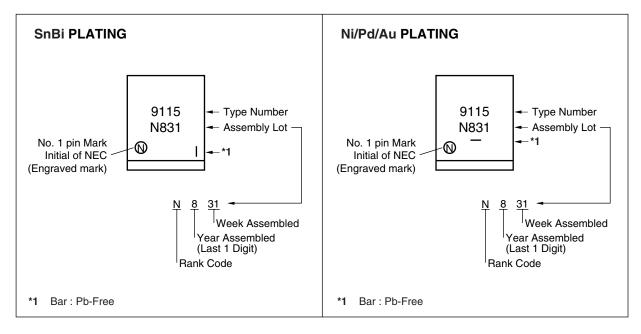
The mark <R> shows major revised points. © NEC Electronics Corporation 2003, 2008

The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.

<R> PACKAGE DIMENSIONS (UNIT: mm)



<R> MARKING EXAMPLE



<R> ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number ^{⁺1}
PS9115	PS9115-A	Pb-Free	20 pcs (Tape 20 pcs cut)	Standard products	PS9115
PS9115-F3	PS9115-F3-A	(SnBi)	Embossed Tape 2 500 pcs/reel	(UL approved)	
PS9115-F4	PS9115-F4-A				
PS9115-V	PS9115-V-A		20 pcs (Tape 20 pcs cut)	DIN EN60747-5-2	
PS9115-V-F3	PS9115-V-F3-A		Embossed Tape 2 500 pcs/reel	(VDE0884 Part2)	
PS9115-V-F4	PS9115-V-F4-A			Approved (Option)	
PS9115	PS9115-AX	Pb-Free	20 pcs (Tape 20 pcs cut)	Standard products	
PS9115-F3	PS9115-F3-AX	(Ni/Pd/Au)	Embossed Tape 2 500 pcs/reel	(UL approved)	
PS9115-F4	PS9115-F4-AX				
PS9115-V	PS9115-V-AX		20 pcs (Tape 20 pcs cut)	DIN EN60747-5-2	
PS9115-V-F3	PS9115-V-F3-AX		Embossed Tape 2 500 pcs/reel	(VDE0884 Part2)	
PS9115-V-F4	PS9115-V-F4-AX			Approved (Option)	

*1 For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (TA = 25°C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit
Diode	Forward Current ^{*1}	lf	30	mA
	Reverse Voltage	VR	5	V
Detector	Supply Voltage	Vcc	7	V
	Output Voltage	Vo	7	V
	High Level Output Current	Іон	-5	mA
	Low Level Output Current	lol	13	mA
	Power Dissipation ²	Pc	130	mW
Isolation	Voltage ³	BV	3 750	Vr.m.s.
Operating Ambient Temperature		TA	-40 to +85	°C
Storage Temperature		Tstg	-55 to +125	°C

*1 Reduced to 0.3 mA/°C at TA = 25° C or more.

*2 T_A = -40 to +85°C, Applies to output pin Vo and power supply pin Vcc. Reduced to 2.36 mW/°C at T_A = 70°C or more.

*3 AC voltage for 1 minute at $T_A = 25^{\circ}$ C, RH = 60% between input and output. Pins 1-2 shorted together, 3-5 shorted together.

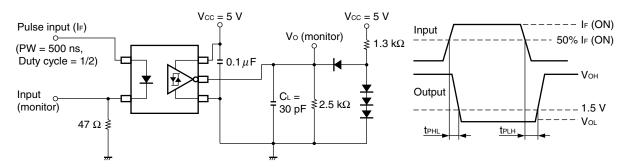
RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
High Level Input Current	Ifh	7.5		12.5	mA
Low Level Input Voltage	VFL	0		0.8	V
Supply Voltage	Vcc	4.5	5.0	5.5	V
TTL (loads)	Ν			3	
Operating Ambient Temperature	TA	0		+85	°C

ELECTRICAL CHARACTERISTICS (TA = 0 to +85°C, unless otherwise specified)

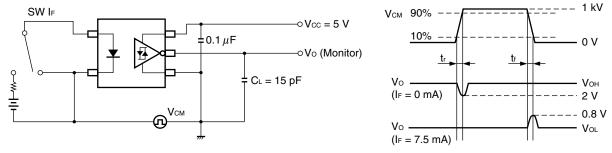
	Parameter	Symbol	Conditions	MIN.	TYP. ^{*1}	MAX.	Unit
Diode	Forward Voltage	VF	I⊧ = 10 mA, T _A = 25°C	1.4	1.65	1.9	V
	Reverse Current	IR	Vr = 3 V, Ta = 25°C			10	μA
	Terminal Capacitance	Ct	V = 0 V, f = 1 MHz, T _A = 25°C		30		pF
Detector	High Level Output Current ^{*2}	Іон	Vcc = Vo = 5.5 V, VF = 0.8 V		0.003	200	μA
	High Level Output Voltage	Vон	$V_{CC} = 4.5 \text{ V}, \text{ V}_{F} = 0.8 \text{ V}, \text{ IOH} = -2 \text{ mA}$	2.4	3.0		V
	Low Level Output Voltage	Vol	Vcc = 4.5 V, I⊧ = 7 mA, Io∟ = 8 mA		0.25	0.6	V
	High Level Supply Current	Іссн	Vcc = 5.5 V, I⊧ = 0 mA, Vo = open		12	16	mA
	Low Level Supply Current	lcc∟	Vcc = 5.5 V, IF = 10 mA, Vo = open		13	16	mA
	High Level Output Short Circuit Current	Іозн	Vcc = 5.5 V, Vo = GND, I⊧ = 0 mA, 10 ms or less		-26		mA
	Low Level Output Short Circuit Current	los∟	Vcc = Vo = 5.5 V, IF = 8 mA, 10 ms or less		34		mA
Coupled	Threshold Input Current	IFHL	$T_A = 25^{\circ}C$		2.3	5	mA
	$(H \rightarrow L)$		Vcc = 5 V, Vo = 0.6 V			6	
	Isolation Resistance	Rı-o	V _{I-O} = 1 kV _{DC} , RH = 40 to 60%, T _A = 25°C	10 ¹¹			Ω
	Isolation Capacitance	CI-O	V = 0 V, f = 1 MHz, T _A = 25°C		0.6		pF
	Propagation Delay Time	tрнL	T _A = 25°C	15	33	65	ns
	$(H \rightarrow L)^{^{*3}}$		Vcc = 5 V, I⊧ = 7.5 mA	10		85	
	Propagation Delay Time	t PLH	T _A = 25°C	15	40	65	ns
	$(L \rightarrow H)^{^{*3}}$		Vcc = 5 V, IF = 7.5 mA	10		85	
	Pulse Width Distortion (PWD) ⁻³	tphl-tplh	Vcc = 5 V, IF = 7.5 mA		7	50	ns
	Common Mode Transient Immunity at High Level Output ^{'4}	СМн	$V_{CC} = 5 \text{ V}, \text{ T}_{A} = 25^{\circ}\text{C}, \text{ I}_{F} = 0 \text{ mA},$ $V_{O (MIN.)} = 2 \text{ V}, \text{ V}_{CM} = 1 \text{ kV}$	10	20		kV/µs
	Common Mode Transient Immunity at Low Level Output ^{*4}	CM∟	Vcc = 5 V, TA = 25°C, IF = 7.5 mA, Vo (max.) = 0.8 V, Vcm = 1 kV	10	20		kV/ <i>µ</i> s

- ***1** Typical values at $T_A = 25^{\circ}C$
- *2 Because a high-level output current (IOH) of 300 μA or more may be output when the temperature is 0°C or less and when Vcc is around 3 to 4 V, it is important to confirm the characteristics (operation with the power supply on and off) during design, before using this device.
- *3 Test circuit for propagation delay time



C∟ includes probe and stray wiring capacitance.

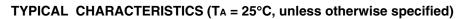
*4 Test circuit for common mode transient immunity

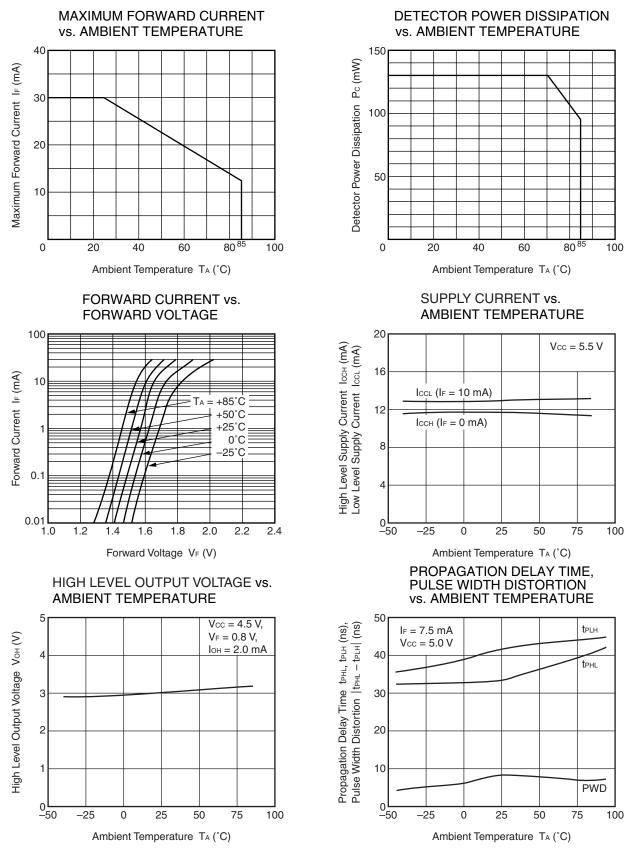


 $C_{\mbox{\tiny L}}$ includes probe and stray wiring capacitance.

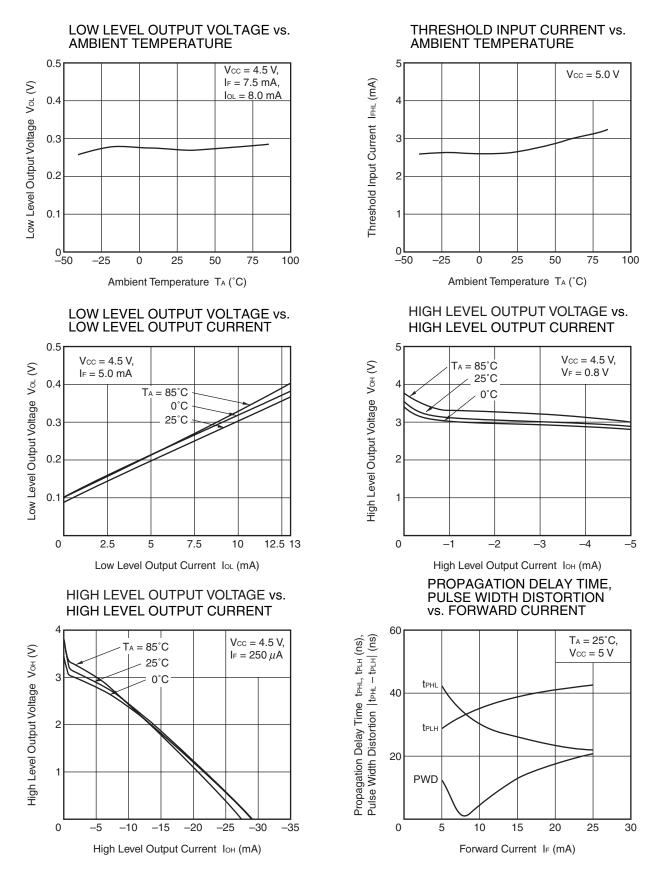
USAGE CAUTIONS

- 1. This product is weak for static electricity by designed with high-speed integrated circuit so protect against static electricity when handling.
- 2. By-pass capacitor of 0.1 μ F is used between Vcc and GND near device. Also, ensure that the distance between the leads of the photocoupler and capacitor is no more than 10 mm.
- 3. Avoid storage at a high temperature and high humidity.



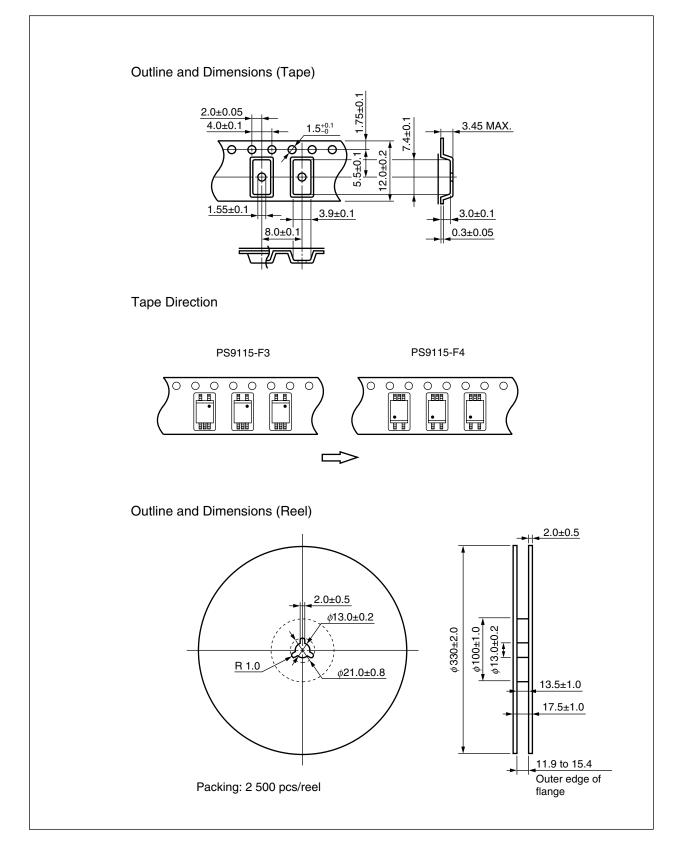


Remark The graphs indicate nominal characteristics.

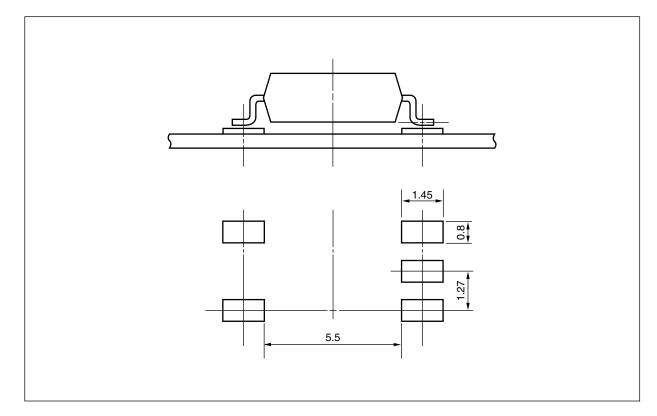


Remark The graphs indicate nominal characteristics.

TAPING SPECIFICATIONS (UNIT: mm)



<R> RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)



NOTES ON HANDLING

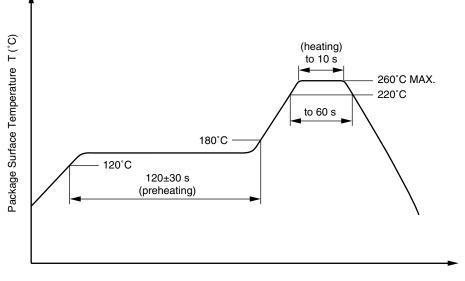
1. Recommended soldering conditions

(1) Infrared reflow soldering

- Peak reflow temperature
- Time of peak reflow temperature
- Time of temperature higher than 220°C
- Time to preheat temperature from 120 to 180°C
- Number of reflows
- Flux

260°C or below (package surface temperature) 10 seconds or less 60 seconds or less 120±30 s Three Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



Time (s)

(2) Wave soldering

- Temperature 260°C or below (molten solder temperature)
- Time 10 seconds or less
- Preheating conditions 120°C or below (package surface temperature)
- Number of times One (Allowed to be dipped in solder including plastic mold portion.)
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(3) Soldering by Soldering Iron

Peak Temperature (lead part temperature)	350°C or below
Time (each pins)	3 seconds or less
• Flux	Rosin flux containing small amount of chlorine (The flux with a
	maximum chlorine content of 0.2 Wt% is recommended.)

- (a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead
- (b) Please be sure that the temperature of the package would not be heated over $100^{\circ}C$

(4) Cautions

• Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

USAGE CAUTIONS

- 1. Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.

<R> SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

Parameter	Symbol	Speck	Unit
Application classification (DIN EN 60664-1 VDE0110 Part 1) for rated line voltages \leq 300 Vr.m.s. for rated line voltages \leq 600 Vr.m.s.		IV III	
Climatic test class (DIN EN 60664-1 VDE0110)		40/85/21	
Dielectric strength maximum operating isolation voltage Test voltage (partial discharge test, procedure a for type test and random test) $U_{pr} = 1.5 \times U_{\text{IORM}}, P_{d} < 5 \text{ pC}$	Uiorm Upr	707 1 061	V _{peak} V _{peak}
Test voltage (partial discharge test, procedure b for all devices) U_{pr} = 1.875 \times U_{IORM}, Pd < 5 pC	Upr	1 326	Vpeak
Highest permissible overvoltage	Utr	6 000	V _{peak}
Degree of pollution (DIN EN 60664-1 VDE0110 Part 1)		2	
Clearance distance		>4.2	mm
Creepage distance		>4.2	mm
Comparative tracking index (DIN IEC 112/VDE 0303 Part 1)	СТІ	175	
Material group (DIN EN 60664-1 VDE0110 Part 1)		III a	
Storage temperature range	Tstg	-55 to +125	°C
Operating temperature range	TA	-40 to +85	°C
Isolation resistance, minimum value $V_{IO} = 500 \text{ V dc at } T_A = 25^{\circ}\text{C}$ $V_{IO} = 500 \text{ V dc at } T_A MAX. at least 100^{\circ}\text{C}$	Ris MIN. Ris MIN.	10 ¹² 10 ¹¹	Ω Ω
Safety maximum ratings (maximum permissible in case of fault, see thermal derating curve) Package temperature Current (input current IF, Psi = 0) Power (output or total power dissipation)	Tsi Isi Psi	150 200 300	°C mA mW
Isolation resistance V _{IO} = 500 V dc at T _A = Tsi	Ris MIN.	10 ⁹	Ω

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M8E 02.11-1

Caution GaAs Products	This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.
	• Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
	 Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
	Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
	• Do not burn, destroy, cut, crush, or chemically dissolve the product.
	Do not lick the product or in any way allow it to enter the mouth.